

1 A Three-quadrant triacs high commutation Rev. 04 — 4 February 2008

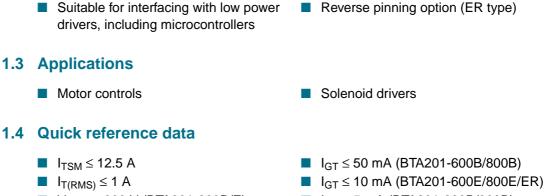
Product data sheet

Product profile 1.

1.1 General description

Passivated, guaranteed commutation triacs in a plastic package. The 'sensitive gate' E and ER series are intended for interfacing with low power drivers, including microcontrollers. The high commutation B series are designed to commutate the full RMS current at the maximum junction temperature without the aid of a snubber.

1.2 Features



- V_{DRM} \leq 600 V (BTA201-600B/E)
- V_{DRM} \leq 800 V (BTA201-800B/E/ER)
- I_{GT} ≥ 5 mA (BTA201-600B/800B)
- I_{GT} ≥ 1 mA (BTA201-600E/800E/ER)

Pinning information 2.

Table 1. Pin	ning		
Pin	Description	Simplified outline	Graphic symbol
B and E series	i i		
1	main terminal 2 (T2)		N 1
2	gate (G)		T2-T1
3	main terminal 1 (T1)		`G sym051
ER series			
1	main terminal 1 (T1)		
2	gate (G)	321	
3	main terminal 2 (T2)	SOT54 (TO-92)	



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3. Ordering information

Table 2. Ordering information							
Type number	Package	Package					
	Name	Description	Version				
BTA201-600B	TO-92	plastic single-ended leaded (through hole) package; 3 leads	SOT54				
BTA201-600E							
BTA201-800B							
BTA201-800E							
BTA201-800ER							

4. Limiting values

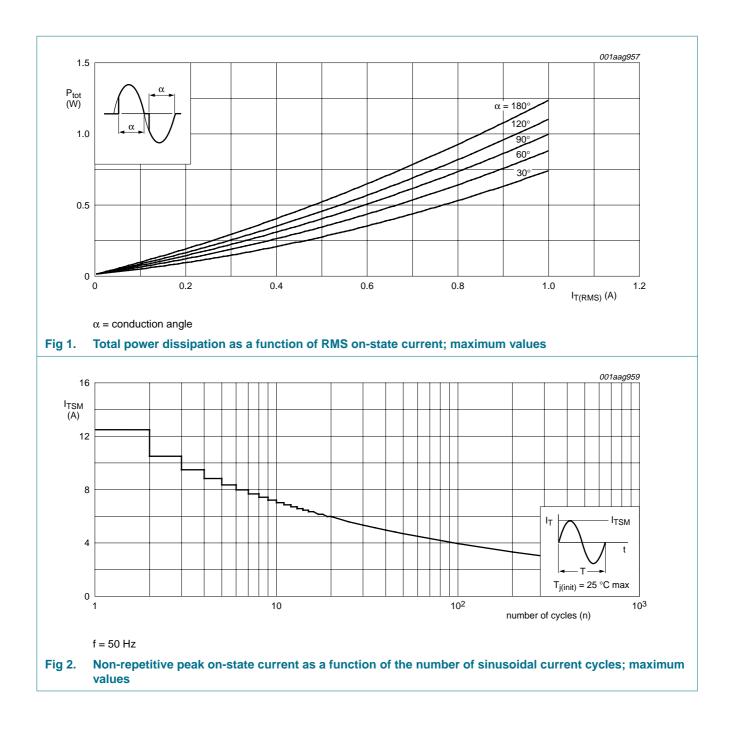
Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DRM}	repetitive peak off-state voltage				
		BTA201-600B	<u>[1]</u> _	600	V
		BTA201-600E	<u>[1]</u> _	600	V
		BTA201-800B	-	800	V
		BTA201-800E	-	800	V
		BTA201-800ER	-	800	V
I _{T(RMS)}	RMS on-state current	full sine wave; $T_{lead} \le 54.3 \text{ °C}$; see Figure 4 and 5	-	1	А
I _{TSM}	non-repetitive peak on-state current	full sine wave; $T_j = 25 \text{ °C prior to}$ surge; see <u>Figure 2</u> and <u>3</u>			
		t = 20 ms	-	12.5	А
		t = 16.7 ms	-	13.7	А
l ² t	I ² t for fusing	t _p = 10 ms	-	0.78	A ² s
dl _T /dt	rate of rise of on-state current	$\begin{split} I_{TM} &= 1.5 \text{ A}; \text{ I}_{G} = 0.2 \text{ A}; \\ dI_{G}/dt &= 0.2 \text{ A}/\mu\text{s} \end{split}$	-	100	A/μs
I _{GM}	peak gate current		-	2	А
P _{GM}	peak gate power		-	5	W
P _{G(AV)}	average gate power	over any 20 ms period	-	0.1	W
T _{stg}	storage temperature		-40	+150	°C
Tj	junction temperature		-	125	°C

 Although not recommended, off-state voltages up to 800 V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 6 A/µs.

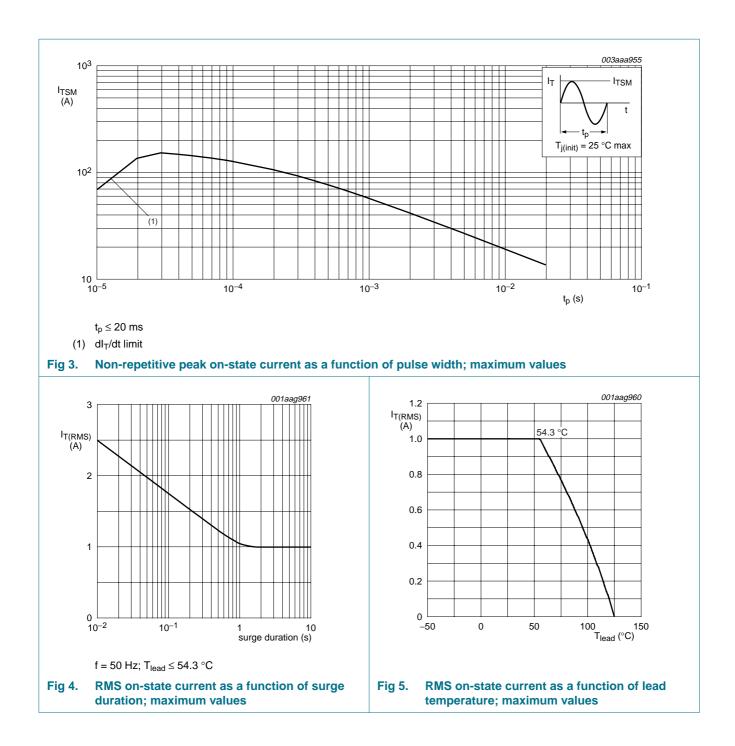
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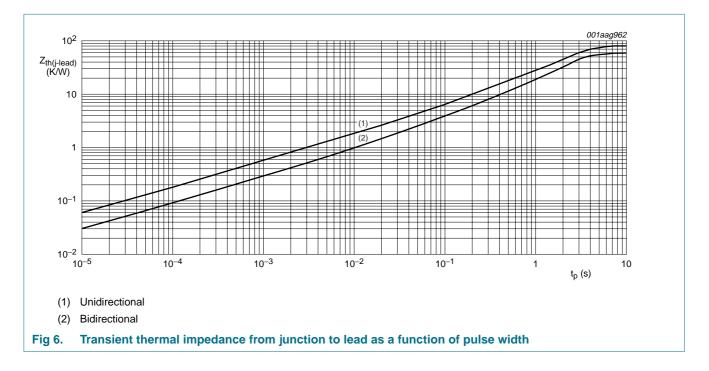
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5. Thermal characteristics

Table 4.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-lead)}	load	full cycle; see Figure 6	-	-	60	K/W
		half cycle; see Figure 6	-	-	80	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	printed-circuit board mounted; lead length = 4 mm	-	150	-	K/W



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6. Static characteristics

Table 5. Static characteristics

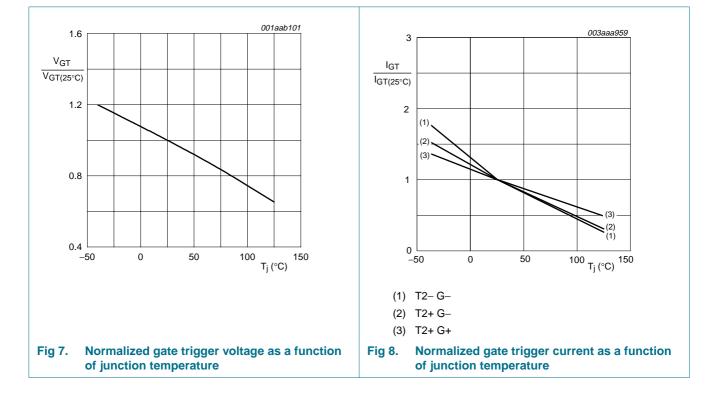
 $T_i = 25 \circ C$ unless otherwise specified.

Symbol	Parameter	Conditions		BTA201-600B BTA201-800B			BTA201-600E BTA201-800E BTA201-800ER		
			Min	Тур	Max	Min	Тур	Max	
I _{GT}	gate trigger current	$V_D = 12 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ see } \frac{\text{Figure 8}}{\text{Figure 8}}$							
		T2+ G+	5	-	50	1	-	10	mA
		T2+ G-	5	-	50	1	-	10	mA
		T2– G–	5	-	50	1	-	10	mA
۱L	latching current	$V_D = 12 \text{ V}; \text{ I}_{GT} = 0.1 \text{ A}; \text{ see } \frac{\text{Figure 10}}{1000000000000000000000000000000000$							
		T2+ G+	-	-	30	-	-	12	mA
		T2+ G-	-	-	50	-	-	20	mA
		T2– G–	-	-	30	-	-	12	mA
I _H	holding current	$V_D = 12 \text{ V}; \text{ I}_{GT} = 0.1 \text{ A}; \text{ see } \frac{\text{Figure 11}}{1000000000000000000000000000000000$	-	-	30	-	-	12	mA
VT	on-state voltage	I _T = 1.4 A; see <u>Figure 9</u>	-	1.2	1.5	-	1.2	1.5	V
V _{GT}	gate trigger voltage	$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ see } \frac{\text{Figure 7}}{100000000000000000000000000000000000$	-	0.7	1.5	-	0.7	1.5	V
		V_D = 400 V; I _T = 0.1 A; T _j = 125 °C	0.2	0.3	-	0.2	0.3	-	V
I _D	off-state current	$V_D = V_{DRM(max)}; T_j = 125 \ ^{\circ}C$	-	0.1	0.5	-	0.1	0.5	mA

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7. Dynamic characteristics

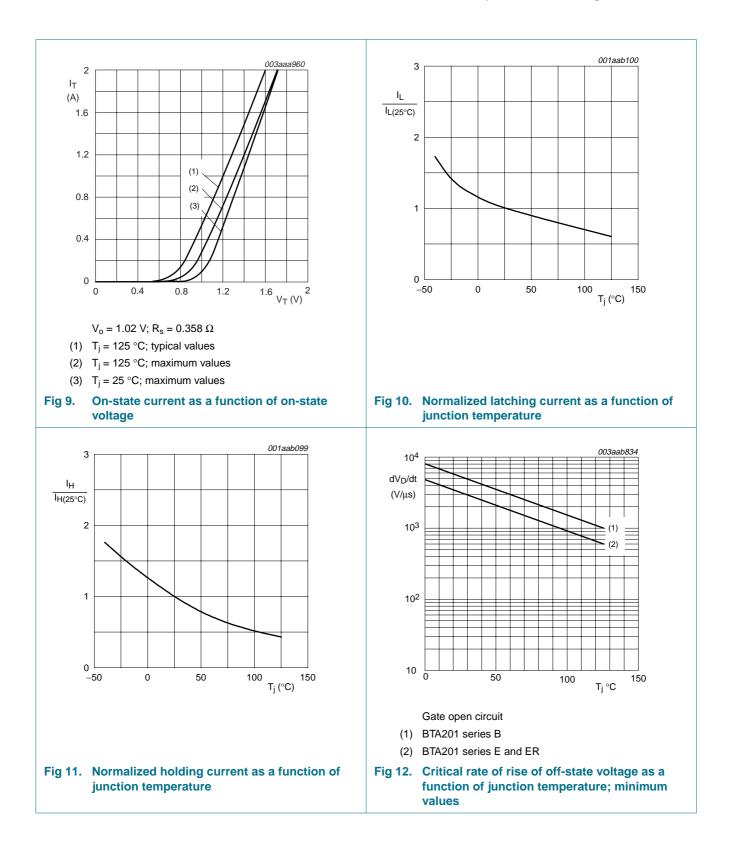
Table 6.	Dynamic characteristics								
Symbol	Parameter	Conditions		BTA201-600B BTA201-800B			BTA201-600E BTA201-800E BTA201-800ER		
			Min	Тур	Max	Min	Тур	Max	
dV _D /dt	rate of rise of off-state voltage	$V_{DM} = 67 \% V_{DRM(max)};$ T _j = 125 °C; exponential waveform; gate open circuit	1000	-	-	600	-	-	V/µs
	rate of change of commutating current	$V_{DM} = 400 \text{ V}; T_j = 125 \text{ °C};$ $dV_{com}/dt = 20 \text{ V}/\mu s;$ gate open circuit	12	-	-	2.5	-	-	A/ms
		$V_{DM} = 400 \text{ V}; T_j = 125 \text{ °C};$ $dV_{com}/dt = 10 \text{ V}/\mu s;$ gate open circuit	16	-	-	3.5	-	-	A/ms
t _{gt}	gate-controlled turn-on time	$\begin{split} I_{TM} &= 20 \text{ A}; \\ V_D &= V_{DRM(max)}; \\ I_G &= 0.1 \text{ A}; \\ dI_G/dt &= 5 \text{ A}/\mu\text{s} \end{split}$	-	2	-	-	2	-	μs



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8. Package outline

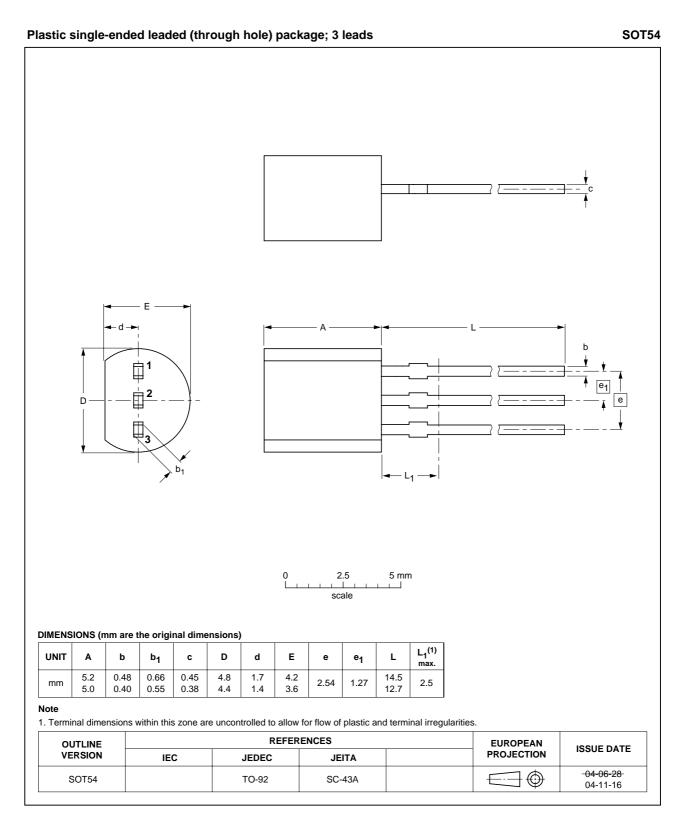


Fig 13. Package outline SOT54 (TO-92)

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9. Revision history

Table 7. Revision history	/			
Document ID	Release date	Data sheet status	Change notice	Supersedes
BTA201_SER_B_E_ER_4	20080204	Product data sheet	-	BTA201_SER_B_E_ER_3
Modifications:	• Figure 3: 0	Changed figure.		
	Section 1.	4 "Quick reference data" on pa	age 1: Updated wit	h minimum I _{GT} values added.
	 <u>Table 3 "Li</u> 	miting values" on page 2: I ² t o	condition, t _p ; symbo	ol update.
	• Table 5 "S	tatic characteristics" on page	<mark>6</mark> : Minimum I _{GT} val	ues added.
BTA201_SER_B_E_ER_3	20070910	Product data sheet	-	BTA201_SER_B_E_ER_2
Modifications:		t of this data sheet has been i of NXP Semiconductors.	redesigned to com	ply with the new identity
	 Legal texts 	s have been adapted to the ne	ew company name	where appropriate.
	 Descriptive 	e titles have been corrected.		
	 Table 3 "Li 	miting values" on page 2: dl _T /	dt uprated.	
	 Table 6 "D 	ynamic characteristics" on pa	ge 7: dV _D /dt uprate	ed.
		"Critical rate of rise of off-state values" on page 8: graph upda		tion of junction temperature;
BTA201_SER_B_E_ER_2	20060113	Product data sheet	-	BTA201_SER_B_E_ER_1
Modifications:	• Figure 4: F	Figure note corrected		
	 Table 6 "D 	ynamic characteristics" on pa	ge 7: Units correcte	ed
	 Figure 12: 	Figure title corrected		
BTA201_SER_B_E_ER_1 (9397 750 15154)	20050825	Product data sheet	-	-

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10. Legal information

10.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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